- Designed for WLAN IF Applications
- Low Insertion Loss
- 9.1 x 7.1 mm Surface-mount Case
- Unbalanced Input and Output
- Complies with Directive 2002/95/EC (RoHS)


## Absolute Maximum Ratings

| Rating | Value | Units |
| :--- | :---: | :---: |
| Maximum Incident Power in Passband | +10 | dBm |
| Max. DC voltage between any 2 terminals | 30 | VDC |
| Storage Temperature Range | -40 to +85 | ${ }^{\circ} \mathrm{C}$ |
| Suitable for lead-free soldering - Max Soldering Profile | $260^{\circ} \mathrm{C}$ for 30 s |  |



SM9171-10

## Electrical Characteristics

| Characteristic | Sym | Notes | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Nominal Center Frequency | $\mathrm{f}_{\mathrm{C}}$ | 1 | 254.500 |  |  | MHz |
| Passband Insertion Loss at fc | IL |  |  | 8.5 | 10.0 | dB |
| Amplitude Ripple over fc $\pm 80 \mathrm{kHz}$ Group Delay Variation over fc $\pm 50 \mathrm{kHz}$ | $\mathrm{BW}_{3}$ | 1, 2 | $\pm 750$ | $\pm 1000$ |  | kHz |
|  |  |  |  | 0.5 | 2.0 | $\mathrm{dB}_{\mathrm{P}-\mathrm{P}}$ |
|  | GDV |  |  | <200 | 250 | $n S_{P-P}$ |
| 90 MHz to fc-50 MHz and fc +50 to 1000 MHz Spurious Rej. at $0.33,0.528,0.594,1.66$, and $1.8 \times \mathrm{fc}$ |  | 1, 2, 3 | 60 |  |  | dB |
|  |  |  | 40 |  |  |  |
| Operating Temperature Range | $\mathrm{T}_{\text {A }}$ | 1 | -10 |  | +60 | ${ }^{\circ} \mathrm{C}$ |


| Impedance Matching to $50 \Omega$ unbalanced | External L-C |
| :--- | :---: |
| Case Style | SM9171-10 $9.1 \times 7.1 \mathrm{~mm}$ Nominal Footprint |
| Lid Symbolization (XX $=2$ character date code) | RFM 1054A-1 XX |

## Electrical Connections

| Connection | Terminals |
| :--- | :---: |
| Input | 10 |
| Ground | 1 |
| Output | 5 |
| Ground | 6 |
| Case Ground | All others |

## Notes:

1. Unless noted otherwise, all specitication apply over the operating temperature range with filter soldered to the specified demonstration board with impedanced matching to $50 \Omega$ network analyzer.
2. Unless noted otherwise, all frequency specitications are referenced to the nominal center frequency, fc.
3. Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent oon PCB layout and external impedance matching design. See Application Note No. 42 for details.
4. "LRIP" or "L" after the part number indicates "low rate initial production" and "ENG" or "E" indicates "engineering prototypes."
5. The design, manufacturing process, and specifications of this filter are subject to change.
6. Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per the circuit design.
7. US and international patents may apply.
8. Electrostatic Sensitive Device. Observe precautions for handling.



## SM9171-10 Case

## 10-Terminal Ceramic Surface-Mount Case <br> $9.1 \times 7.1$ mm Nominal Footprint



| Case Dimensions |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Dimension | mm |  |  | Inches |  |  |
|  | Min | Nom | Max | Min | Nom | Max |
| A | 8.86 | 9.09 | 9.40 | 0.349 | 0.358 | 0.370 |
| B | 6.88 | 7.11 | 7.40 | 0.271 | 0.280 | 0.291 |
| C |  | 1.91 | 2.00 |  | 0.075 | 0.079 |
| D |  | 0.99 |  |  | 0.039 |  |
| E |  | 0.79 |  |  | 0.031 |  |
| H |  | 1.0 |  |  | 0.039 |  |
| P |  | 2.54 |  |  | 0.100 |  |


| Materials |  |
| :--- | :--- |
| Solder Pad <br> Termination | Au plating 30-60 ulnches (76.2-152 uM) over 80- <br> 200 ulnches (203-508 uM) Ni. |
| Lid | Fe-Ni-Co Alloy Electroless Nickel Plate (8-11\% <br> Phosphorus) 100-200 ulnches Thick |
| Body | $\mathrm{Al}_{2} \mathrm{O}_{3}$ Ceramic |
| Pb Free |  |


| Electrical Connections |  |
| :---: | :---: |
| Connection | Terminals |
| Input | 10 |
| Ground | 1 |
| Output | 5 |
| Ground | 6 |
| Case Ground | All others |
| Single Ended Operation | Return is ground |
| Differential Operation | Return is hot |



